



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Mayer et al.

Atty Dkt No: NOVLP081D1/NVLS-000261

Application No.: 09/716,016

Examiner: Leader, William

Filed: November 16, 2000

Group: 1741

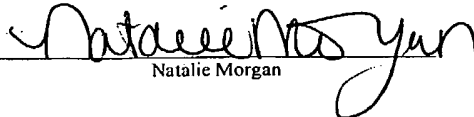
Title: PROCESS FOR ELECTROPLATING  
METALS INTO MICROSCOPIC RECESSED  
FEATURES

Confirmation No: 7163

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on March 26, 2004 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed:

  
Natalie Morgan

**AMENDMENT B**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed February 4, 2004 ("Office Action"), please amend the above-identified patent application as follows:

A Listing of Claims begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.

Enter  
W/Leader  
4/19/2004